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April 2009

# FIN1017 3.3V LVDS, 1-Bit, High-Speed Differential Driver

### **Features**

- Greater than 600Mbs Data Rate
- 3.3V Power Supply Operation
- 0.5ns Maximum Differential Pulse Skew
- 1.5ns Maximum Propagation Delay
- Low Power Dissipation
- Power-Off Protection
- Meets or Exceeds the TIA/EIA-644 LVDS Standard
- Flow-Through Pinout Simplifies PCB Layout
- 8-Lead SOIC and US8 Packages Save Space

## **Description**

This single driver is designed for high-speed interconnects utilizing Low Voltage Differential Signaling (LVDS) technology. The driver translates LVTTL signal levels to LVDS levels with a typical differential output swing of 350mV, which provides low EMI at ultra-low power dissipation even at high frequencies. This device is ideal for high-speed transfer of clock or data.

The FIN1017 can be paired with its companion receiver, the FIN1018, or with any other LVDS receiver.

## **Ordering Information**

Part Number	Operating Temperature Range	© Eco Status	Package	Packing Method
FIN1017MX	-40 to +85°C	Green	8-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150inch Narrow	Tape and Reel
FIN1017K8X	-40 to +85°C	Green	8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide	Tape and Reel

For Fairchild's definition of Eco Status, please visit: http://www.fairchildsemi.com/company/green/rohs\_green.html

## **Pin Configuration**

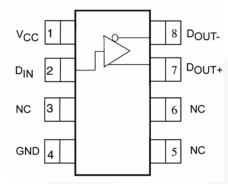


Figure 1. SOIC

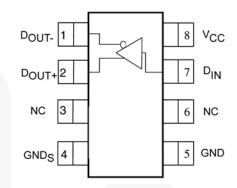


Figure 2. US-8 (Top View)<sup>(1)</sup>

### Note:

1. Ground pins 4 and 5 for optimum performance.

## **Pin Definitions**

Pin# US-8	Pin# SOIC	Name	Description
7	2	D <sub>IN</sub>	LVTTL Data Input
2	7	D <sub>OUT+</sub>	Non-inverting Driver Output
1	8	D <sub>OUT</sub> -	Inverting Driver Output
8	1	V <sub>CC</sub>	Power Supply
4, 5	4	GND / GND <sub>S</sub>	Ground
3, 6	3, 5, 6	NC	No Connect

## **Function Table**

Input	Outputs			
D <sub>IN</sub>	D <sub>OUT+</sub>	D <sub>OUT</sub> .		
LOW Logic Level	LOW Logic Level	HIGH Logic Level		
HIGH Logic Level	HIGH Logic Level	LOW Logic Level		
OPEN	LOW Logic Level	HIGH Logic Level		

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
V <sub>CC</sub>	Supply Voltage	-0.5	+4.6	V
D <sub>IN</sub>	DC Input Voltage	-0.5	+6.0	V
D <sub>OUT</sub>	DC Output Voltage	-0.5	+4.7	V
I <sub>OSD</sub>	Driver Short-Circuit Current	Continuous		Α
T <sub>STG</sub>	Storage Temperature Range	-65	+150	°C
$T_J$	Max Junction Temperature		+150	°C
$T_L$	Lead Temperature (Soldering, 10 Seconds)		+260	°C
	Human Body Model, JESD22-A114		≥ 6500	
ESD	Bus Pins D <sub>OUT+</sub> /D <sub>OUT-</sub> to GND		≥ 10500	V
	Machine Model, JESD22-A115	1	≥ 350	

XXX NOTE to Engineering - ESD values here do NOT match what's on WWW (pulled from PeopleSoft). XXX

## **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
V <sub>CC</sub>	Supply Voltage	3.0	3.6	V
V <sub>IN</sub>	Input Voltage	0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature	-40	+85	°C

### **DC Electrical Characteristics**

Over-supply voltage and operating temperature ranges, unless otherwise specified. All typical values are at  $T_A = 25$ °C and with  $V_{CC} = 3.3V$ .

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
V <sub>OD</sub>	Output Differential Voltage		250	350	450	mV
$\Delta V_{\text{OD}}$	V <sub>OD</sub> Magnitude Change from Differential LOW-to-HIGH	D. 100 O. Saa Figura 2			25	mV
Vos	Offset Voltage	$R_L = 100 \Omega$ , See Figure 3	1.125	1.250	1.375	V
ΔV <sub>OS</sub>	Offset Magnitude Change from Differential LOW-to-HIGH				25	mV
l <sub>OFF</sub>	Power-Off Output Current	$V_{CC} = 0V$ , $V_{OUT} = 0V$ or 3.6V			±20	mA
	Chart Circuit Output Current	V <sub>OUT</sub> = 0V			-8	mA
I <sub>OS</sub>	Short-Circuit Output Current	$V_{OD} = 0V$			±8	
V <sub>IH</sub>	Input HIGH Voltage		2		Vcc	V
V <sub>IL</sub>	Input LOW Voltage		GND		0.8	V
I <sub>IN</sub>	Input Current	$V_{IN} = 0V \text{ or } V_{CC}$	\		±20	mA
I <sub>I(OFF)</sub>	Power-Off Input Current	$V_{CC} = 0V, V_{IN} = 0V \text{ or } 3.6V$			±20	mA
V <sub>IK</sub>	Input Clamp Voltage	I <sub>IK</sub> = -18mA	-1.5			V
. D-	Davier Comple Compart	No Load, V <sub>IN</sub> = 0V or V <sub>CC</sub>			8	mA
I <sub>CC</sub>	Power Supply Current	$R_L = 100\Omega$ , $V_{IN} = 0V$ or $V_{CC}$			10	mA
C <sub>IN</sub>	Input Capacitance			4		pF
C <sub>OUT</sub>	Output Capacitance			6		pF

### **AC Electrical Characteristics**

Over-supply voltage and operating temperature ranges, unless otherwise specified. All typical values are at  $T_A = 25$ °C and with  $V_{CC} = 3.3$ V. XXX there ARE no Typical values! XXX

Symbol	Parameter	Test Conditions	Min.	Max.	Units
t <sub>PLHD</sub>	Differential Propagation Delay, LOW-to-HIGH		0.5	1.5	ns
t <sub>PHLD</sub>	Differential Propagation Delay, HIGH-to-LOW		0.5	1.5	ns
t <sub>TLHD</sub>	Differential Output Rise Time (20% to 80%)	$R_L = 100\Omega, C_L = 10pF,$	0.4	1.0	ns
t <sub>THLD</sub>	Differential Output Fall Time (80% to 20%)	see Figure 4 and Figure 5	0.4	1.0	ns
t <sub>SK(P)</sub>	Pulse Skew  tplh - tphl			0.5	ns
t <sub>SK(PP)</sub>	Part-to-Part Skew <sup>(2)</sup>			1.0	ns

#### Note:

2. t<sub>SK(PP)</sub> is the magnitude of the difference in propagation delay times between any specified terminals of two devices switching in the same direction (either LOW-to-HIGH or HIGH-to-LOW) when both devices operate with the same supply voltage, same temperature, and have identical test circuits.

## **Test Diagrams**

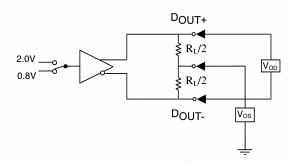


Figure 3. Differential Driver DC Test Circuit

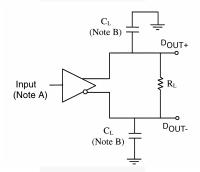


Figure 4. Differential Driver Propagation Delay and Transition Time Test Circuit

### Notes:

Note A: All input pulses have frequency = 10MHz,  $t_R$  or  $t_F = 2ns$ .

Note B: C<sub>L</sub> includes all probe and fixture capacitances.

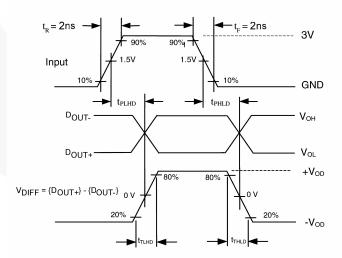


Figure 5. AC Waveforms

## **Typical Performance Characteristics**

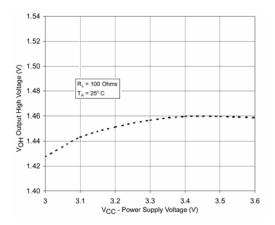


Figure 6. Output High Voltage vs. Power Supply Voltage

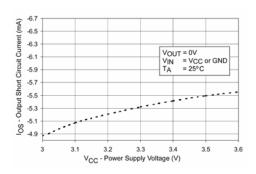


Figure 8. Output Short Circuit Current vs. Power Supply Voltage

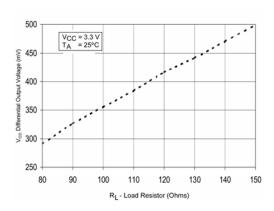


Figure 10.Differential Output Voltage vs. Load Resistor

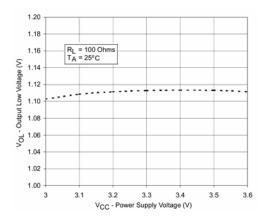


Figure 7. Output Low Voltage vs. Power Supply Voltage

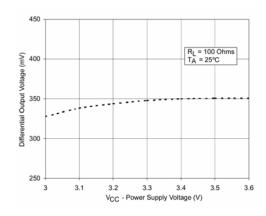


Figure 9. Differential Output Voltage vs. Power Supply Voltage

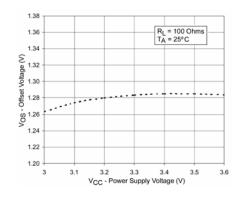
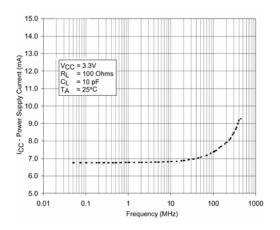


Figure 11.Offset Voltage vs. Power Supply Voltage

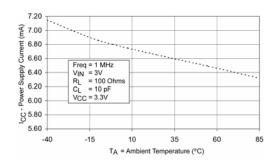
## **Typical Performance Characteristics**



7.20 7.10 TA = 25°C Freq = 1 MHz V<sub>IN</sub> = 0V to 3V R<sub>L</sub> = 100 Ohms C<sub>L</sub> = 10 pF 7.00 6.90 6.80 6.70 6.60 6.50 8 6.40 6.30 3.0 3.6 3.1 3.2 3.3 3.4 3.5 V<sub>CC</sub> - Power Supply Voltage (V)

Figure 12. Power Supply Current vs. Frequency

Figure 13.Power Supply Current vs. Power Supply Voltage



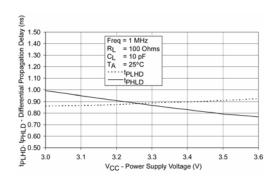
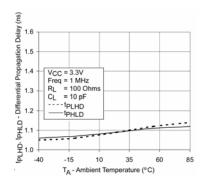


Figure 14.Power Supply Current vs.

Ambient Temperature

Figure 15.Differential Propagation Delay vs. Power Supply



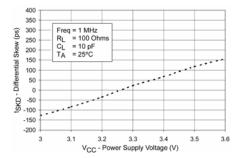
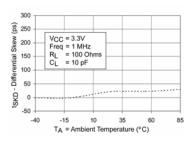


Figure 16.Differential Propagation Delay vs.

Ambient Temperature

Figure 17. Differential Pulse Skew (t<sub>PLH</sub> - t<sub>PHL</sub>) vs. Power Supply Voltage

## **Typical Performance Characteristics**



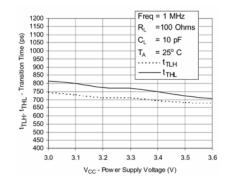


Figure 18.Differential Pulse Skew (t<sub>PLH</sub> - t<sub>PHL</sub>) vs. Ambient Temperature

Figure 19. Transition Time vs. Power Supply Voltage

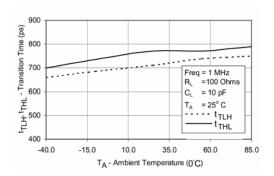


Figure 20. Transition Time vs. Ambient Temperature

### **Physical Dimensions**

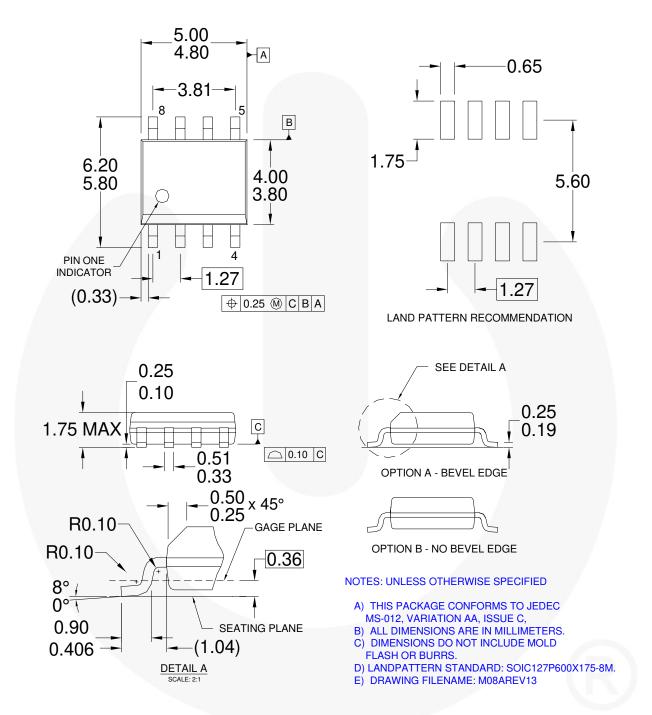
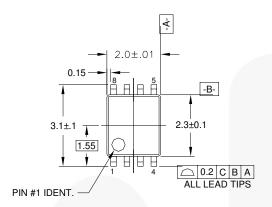


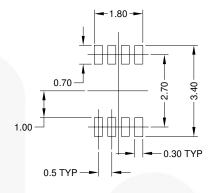
Figure 21.8-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150inch Narrow

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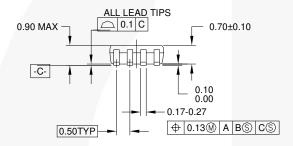
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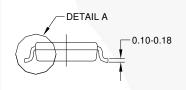
## **Physical Dimensions**

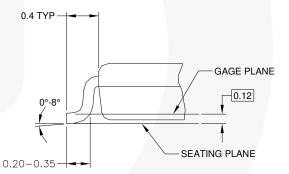




#### LAND PATTERN RECOMMENDATION







### NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-187
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

### **DETAIL A**

#### MAB08AREVC

### Figure 22.8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide

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No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.	
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